TE Internal #: 1-1761465-1

PCI & PCI Express Connectors, Board-to-Board, 36 Position, .039 in

[1 mm] Centerline, Right Angle, Black, Height .37 in [9.4 mm]

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Connectors > PCB Connectors > Card Edge Connectors > PCI & PCI Express Connectors











Connector System: Board-to-Board

Number of Positions: 36

Centerline (Pitch): 1 mm [ .039 in ]

Termination Post & Tail Length: 3.1 mm [.122 in]

Contact Mating Area Plating Material Thickness: [30 µin]

#### **Features**

### **Product Type Features**

Connector & Contact Terminates To	Printed Circuit Board
Connector System	Board-to-Board
Sealable	No

# **Configuration Features**

Number of PCB Mount Retention Features	2
Number of Positions	36
PCB Mount Orientation	Right Angle
Ejector	Without

## **Electrical Characteristics**

Operating Voltage	50 VAC	

## **Body Features**

Product Weight	21.302 g
Primary Product Color	Black

#### **Contact Features**

Contact Mating Area Plating Material	Gold	
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Nickel  Tin  Phosphor Bronze  1.1 A  30 µin
Phosphor Bronze  1.1 A
1.1 A
30 μin
Through Hole - Solder
3.1 mm[.122 in]
Board Mount
High Temperature Nylon
1 mm[.039 in]
1.57 mm[.062 in]
9.4 mm[.37 in]
19.6 mm[.772 in]
-40 - 85 °C[-40 - 185 °F]
Signal
Signal
Signal PCI Express

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant



China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**





# Customers Also Bought





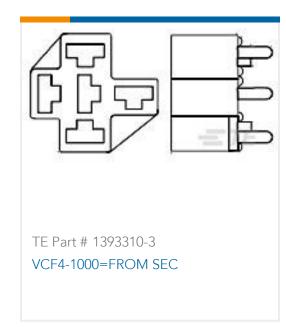


















### **Documents**

### **Product Drawings**

PCI Express RA assy 5.8mm slot 3.1mm pc

English

### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_1-1761465-1\_C.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1-1761465-1\_C.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1-1761465-1\_C.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions**of use.

# Datasheets & Catalog Pages

4-1773442-7 Card Edge Connector for PCI Express Applications

English

## **Product Specifications**

**Application Specification** 

English